

给您一颗快乐的"芯"!

YSX2012SK









Features

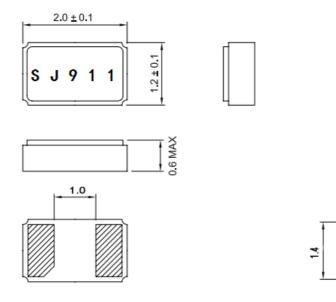
- · External dimensions: 2.00 x 1.20 x 0.60 mm.
- · Standard Frequency: 32.768KHz.
- · Applications in mobile phone, Notebook and DSC.

Electrical Specifications	
Item / Type	YSX2012SK
Standard Frequency Frequency	32.768KHz
Tolerance(at 25)	± 20 ppm , or specify
Load Capacitance (CL)	12.5 pF, or specify
Parabolic Coefficient (B)	(-0.03 ± 0.01) * 10 ⁻⁶ /
Turnover Temperature (Ti)	25 ±5
Operation Temperature Range	-40~+85
Shunt Capacitance (C0)	1.3pF typical
Motional Capacitance (C1)	7.0fF typical
Level Of Drive	0.1 μW
Frequency Aging (at 25 °C)	± 3 ppm / year Max.
Storage Temperature	-55 ~ + 125 ℃

Equivalent Series Resistance(ESR) YSX20125K

90KΩMax.

Dimensions



[///:]

Connection

Suggested Layout

8.0

Units: mm



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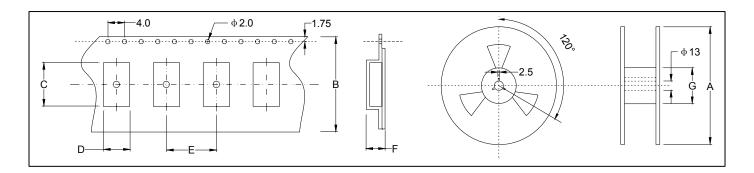


★ PART NUMBER GUIDE 部件号示例 e.g. X201232768KGB2SI

YSX2012SK=2.00×1.20 *SMD SEAM TYPE*

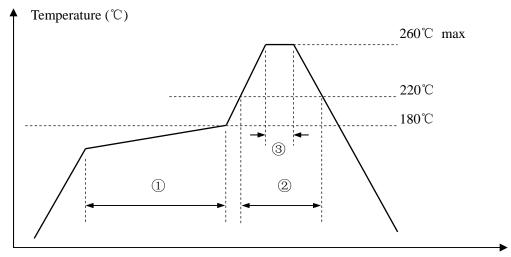
Quartz Crystal Resonator	Dimensions	Frequency (Hz)	Load Capacitance (Pf)	Frequency Stability Overall (ppm)	Pin	Material	Operating Temp. Range
X	2012	32.768K	G	В	2	S	I

★ TAPING SPECIFICATION (Unit: mm) 编带规格



	A	В	С	D	E	F	G
SMD2012	178.0	8.0 ± 0.2	2.30±0.01	1.90±0.01	4.0 ± 0.1	0.90 ± 0.01	60.0 ± 1.0
5000 pcs per reel							

★ REFLOW SOLDERING PROFILE 回流焊特性



Times (S)

Db froe reflow	1	Preheat	170~180℃	120sec. max	
Pb free reflow	2	Primary heat	220℃	60sec. max	
A	(3)	Peak	260℃	10sec. max.	